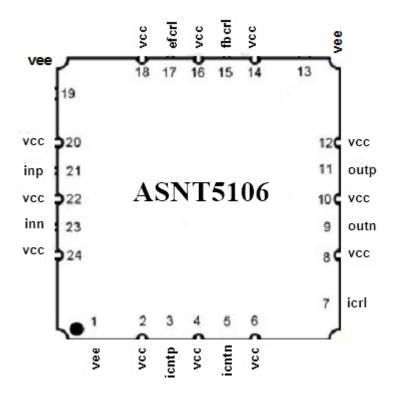


Ultra High-Speed Mixed Signal ASICs

Offices: 310-530-9400 / Fax: 310-530-9402 www.adsantec.com

ASNT5106-KHC DC-32Gbps/26GHz Signal Phase Shifter

- Broadband tunable data/clock phase shifter
- Manual control of power consumption / operational speed
- 1*GHz* of bandwidth for the phase adjustment tuning port
- Automatic temperature and process corner delay compensation with manual override
- Duty cycle distortion compensation with adjustable gain
- Manual internal peaking control
- Fully differential CML input interface
- Fully differential CML output interface
- Single +3.3V or -3.3V power supply
- Fabricated in SiGe for high performance, yield, and reliability
- Custom CQFN 24-pin package





DESCRIPTION

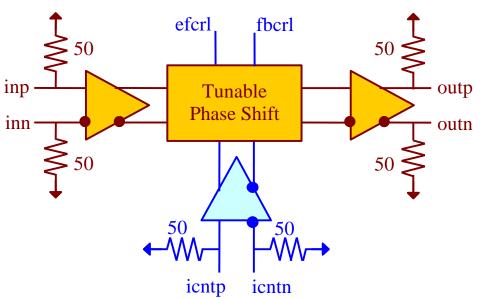


Fig. 1. Functional Block Diagram

ASNT5106-KHC is a data/clock variable delay line with an advanced control system fabricated in SiGe technology. The IC shown in Fig. 1 provides an adjustable delay of its differential output signal **outp/outn** in relation to its broadband input signal **inp/inn**. The delay is controlled through a wide-band differential tuning port **icntp/icntn**. The chip incorporates an automatic common-mode offset cancellation circuit that operates with either clock signals or data signals with balanced patterns. In case of non-balanced data patterns, the circuit should be disabled through a control port **fbcrl**. The single-ended control port **efcrl** can be used to manipulate internal peaking in the delay block in order to adjust the part's frequency response and thus improve output eye diagrams for various data rates and operating conditions.

The part's I/Os support the CML logic interface with on chip 50*Ohm* termination to vcc and may be used differentially, AC/DC coupled, single-ended, or in any combination (see also POWER SUPPLY CONFIGURATION). In the DC-coupling mode, the input signal's common mode voltage should comply with the specifications shown in ELECTRICAL CHARACTERISTICS. In the AC-coupling mode, the input termination provides the required common mode voltage automatically. The differential DC signaling mode is recommended for optimal performance.

The part's power consumption can be adjusted between its minimum (default) and maximum values using a single-ended analog control port **icrl**. It should be noted that higher power leads to higher operational speed of the part.

Due to an extremely low jitter, the part is suitable for use in high-speed measurement / test equipment.

Delay Control Port

The delay is controlled through a wide-band differential tuning port icntp/icntn. This part's delay control system was designed to minimize output jitter and increase the control function linearity. To achieve the goals, the control system is split so that each delay stage has its own control buffer. Only three stages

Rev. 1.0.3



operate in interpolation mode at any delay position, and all the other stages are fully switched either to the short path or to the long path.

The measured diagram of phase delay versus the difference between icntp and icntn for nominal conditions is shown in Fig. 2.

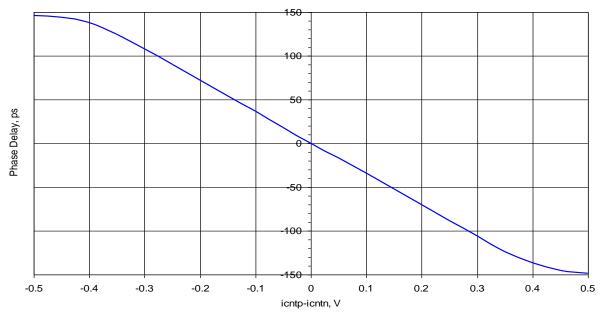


Fig. 2. Delay Control Diagram

Feedback Gain Control Port

This part has two duty cycle correction feedback loops. In case of feedback malfunction, currents inside feedback amplifiers can be manually adjusted or completely shut down through a single-ended tuning port **fbcrl**. The simulated dependence of feedback reference current on the control voltage is shown in Fig. 3. Higher feedback amplifier currents result in higher feedback gain and lower stability. If the port is left not connected, it defaults to an internal level of vcc-0.66V, the feedback current is half its maximum value and the phase shifter is in normal operating mode.

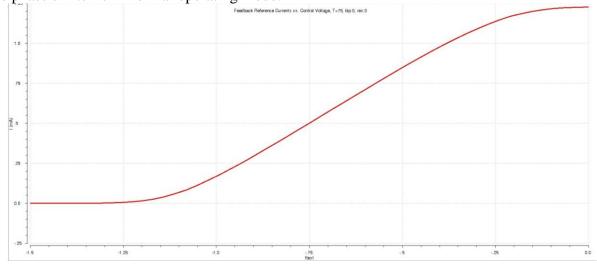


Fig. 3 Simulated Internal Feedback Current vs. Control Voltage



Internal Peaking Control Port

Depending on the data rate and operational conditions, the part's output eye diagram may get distorted because of jitter caused by parasitic internal peaking. Internal peaking can be adjusted by varying currents of internal emitter followers through a single-ended port **efcrl**. The simulated dependence of reference current of internal emitter followers on the control voltage is shown in Fig. 4. If this port is left not connected, it defaults to an internal level of **vcc**-0.66V and, emitter follower currents are half of their maximum values and the circuit is in normal operating mode.

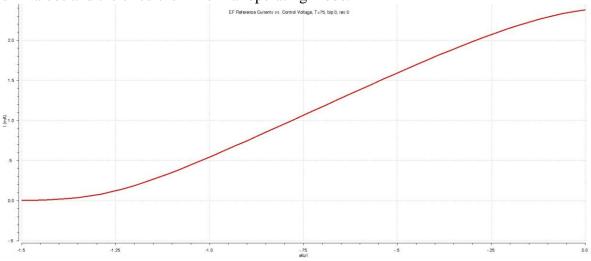


Fig. 4. Simulated Internal EF Reference Current vs. Control Voltage

POWER SUPPLY CONFIGURATION

The part can operate with either a negative supply (vcc = 0.0V=ground), or a positive supply (vee = 0.0V=ground). In case of a positive supply, all I/Os need AC termination when connected to any devices with 50*Ohm* termination to ground. Different PCB layouts will be needed for each different power supply combination.

The part's power consumption can be adjusted between its minimum and maximum values using a singleended analog control port icrl. Higher voltages at the control input correspond to higher power consumption. With the non-connected control port, the part defaults to minimum power consumption. It should be noted that higher power consumption leads to higher operational speed of the part as detailed in ELECTRICAL CHARACTERISTICS.

All the characteristics detailed below assume vcc = 0.0V.



ABSOLUTE MAXIMUM RATINGS

Caution: Exceeding the absolute maximum ratings shown in Table 1 may cause damage to this product and/or lead to reduced reliability. Functional performance is specified over the recommended operating conditions for power supply and temperature only. AC and DC device characteristics at or beyond the absolute maximum ratings are not assumed or implied. All min and max voltage limits are referenced to ground (assumed vcc).

Parameter	Min	Max	Units
Supply Voltage (vee)		-3.6	V
Power Consumption		1.7	W
RF Input Voltage Swing (SE)		1.0	V
Case Temperature		+90	°С
Storage Temperature	-40	+100	°С
Operational Humidity	10	98	%
Storage Humidity	10	98	%

Table 1. Absolute Maximum Ratings

TERMINAL FUNCTIONS

TERMINAL		DESCRIPTION				
Name	No.	Туре				
High-Speed I/Os						
inp	21	CML	Differential high-speed signal inputs with internal SE 500hm			
inn	23	input	termination to VCC			
icntp	3	input	Differential control input with internal SE 500hm terminations to			
icntn	5	input	VCC			
icrl	7	input	SE DC analog control input with internal 11.5KOhm termination			
			to vee			
fbcrl	15	input	SE DC control input terminated to internal resistive divider			
efcrl	17	input	between vee and vcc			
outp	11	CML	Differential high-speed signal outputs with internal SE 500hm			
outn	9	output	termination to vcc. Require external SE 50 <i>Ohm</i> termination to vcc			
	Supply And Termination Voltages					
Name	Description			Pin Number		
vcc	vcc Positive power supply (+3.3V or 0)		r supply $(+3.3V \text{ or } 0)$	2, 4, 6, 8, 10, 12, 14, 16, 18, 20, 22, 24		
vee	Negative power supply $(0V \text{ or } -3.3V)$		r supply (0V or -3.3V)	1, 13, 19		



ELECTRICAL CHARACTERISTICS

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS	
		G	eneral Pa	rameters	5	
vee	-3.1	-3.3	-3.5	V	±6%	
VCC		0.0		V	External ground	
Ivee	327		440	mА	Adjustable	
Power consumption	1080		1450	mW	Adjustable	
Junction temperature	-25	50	125	°C		
HS Input Data/Clock (inp/inn)						
Data Rate	DC		32	Gbps		
Frequency	DC		20	GHz	At minimum power consumption	
	DC		26	GHz	At maximum power consumption	
Swing	0.05		1.0	V	Differential or SE, p-p	
CM Voltage Level	vcc-0.8		VCC	V	Must match for both inputs	
HS Output Data/Clock (outp/outn)						
Data Rate	DC		32	Gbps		
Frequency	DC		20	GHz	At minimum power consumption	
	DC		26	GHz	At maximum power consumption	
Logic "1" level		VCC		V		
Logic "0" level	V	cc-0.44		V	With external 500hm DC termination.	
Rise/Fall times	9		11	ps	20%-80%	
Output Jitter		3.0		ps	For PRBS input, peak-to-peak	
Duty cycle	45	50	55	%	For clock signal	
		Ou	tput-to-I	nput Dela	Ŋ	
Phase shift	0		290	ps	For the full range of phadj control signal	
Phase shift stability	-10		10	ps	0-125°C junction temperature	
Absolute delay stability	-25		25	ps	0-125°C junction temperature	
	Tuning port (icntp/icntn)					
Bandwidth	DC		1000	MHz		
Control voltage range	vcc-100	0	VCC	mV	Default voltage is vcc	
•		r	Funing p	ort (icrl)	·	
Control voltage range	vee		VCC	mV	Default voltage is vee	
	Tuning port (fbcrl)					
Control voltage range	vcc-130		VCC	mV	Default voltage is vcc-0.66V	
Tuning port (efcrl)						
Control voltage range	vcc-130	0	VCC	mV	Default voltage is vcc-0.66V	



PACKAGE INFORMATION

The chip die is housed in a custom 24-pin CQFN package shown in Fig. . The package provides a center heat slug located on its back side to be used for heat dissipation. ADSANTEC recommends for this section to be soldered to the **vcc** plain, which is ground for a negative supply, or power for a positive supply.

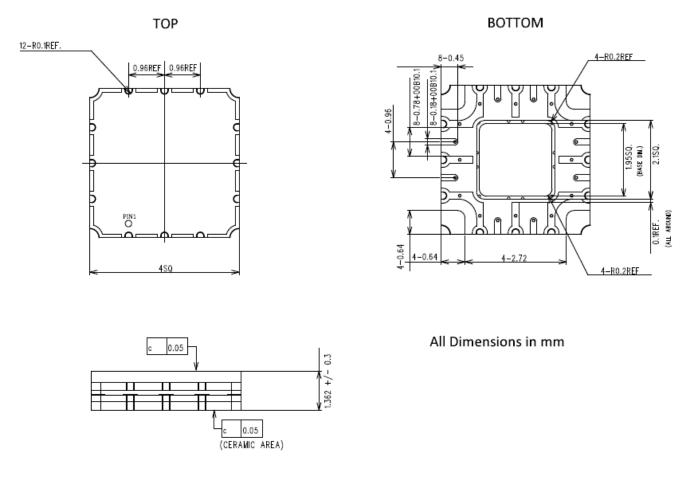


Fig. 5. CQFN 24-Pin Package Drawing (All Dimensions in mm)

The part's identification label is ASNT5106-KHC. The first 8 characters of the name before the dash identify the bare die including general circuit family, fabrication technology, specific circuit type, and part version while the 3 digits after the underscore represent the package's manufacturer, type, and pin out count.

This device complies with Commission Delegated Directive (EU) 2015/863 of 4 June 2015 amending Annex II to Directive 2011/65/EU of the European Parliament and of the Council as regards the list of restricted substances (Text with EEA relevance) on the restriction of the use of certain hazardous substances in electrical and electronics equipment (RoHS Directive) in accordance with the definitions set forth in the directives for all ten substances.



REVISION HISTORY

Revision	Date	Changes		
1.0.3	04-2023	Updated Package Drawing		
1.0.2	08-2021	First Release		